

Complementary MOSFET

ELM35604KA-S

■ General Description

ELM35604KA-S uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■ Features

N-channel	P-channel
$V_{ds}=30V$	$V_{ds}=-30V$
$I_d=8.5A$	$I_d=-7A$
$R_{ds(on)} < 21m\Omega (V_{gs}=10V)$	$R_{ds(on)} < 35m\Omega (V_{gs}=-10V)$
$R_{ds(on)} < 32m\Omega (V_{gs}=4.5V)$	$R_{ds(on)} < 60m\Omega (V_{gs}=-4.5V)$

■ Maximum Absolute Ratings

Parameter	Symbol	N-ch (Max.)	P-ch (Max.)	Unit	Note
Drain-source voltage	V_{ds}	30	-30	V	
Gate-source voltage	V_{gs}	± 20	± 20	V	
Continuous drain current	I_d	8.5	-7.0	A	
		7.0	-5.8		
Pulsed drain current	I_{dm}	50	-50	A	1
Power dissipation	P_d	3.0	3.0	W	
		2.1	2.1		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	-55 to 150	°C	

■ Thermal Characteristics

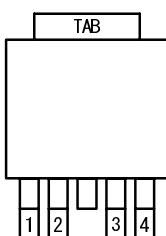
Parameter	Symbol	Device	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	N-ch		42	°C/W	
Maximum junction-to-case	$R_{\theta jc}$	N-ch		6	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$	P-ch		42	°C/W	
Maximum junction-to-case	$R_{\theta jc}$	P-ch		6	°C/W	

1. Pulse width limited by maximum junction temperature.

2. Duty cycle $\leq 1\%$.

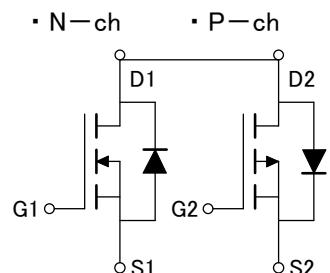
■ Pin Configuration

TO-252-4 (TOP VIEW)



Pin No.	Pin name
1	SOURCE1
2	GATE1
3	SOURCE2
4	GATE2
TAB	DRAIN1/DRAIN2

■ Circuit



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■ Electrical Characteristics (N-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250 μA, Vgs=0V	30			V	
Zero gate voltage drain current	Idss	Vds=24V, Vgs=0V			1	μA	
		Vds=20V, Vgs=0V, Tj=55°C			10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μA	0.8	1.5	2.5	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V	50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=8A		17.5	21.0	mΩ	1
		Vgs=4.5V, Id=6A		24.0	32.0		
Forward transconductance	Gfs	Vds=10V, Id=8A			13	S	1
Diode forward voltage	Vsd	If=3A, Vgs=0V			1.2	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		1200		pF	
Output capacitance	Coss			180		pF	
Reverse transfer capacitance	Crss			160		pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=10V, Vds=15V, Id=8A		16		nC	2
Gate-source charge	Qgs			6		nC	2
Gate-drain charge	Qgd			8		nC	2
Turn-on delay time	td(on)	Vgs=10V, Vds=15V, Id ≈ 1A Rgen=3.3 Ω		20		ns	2
Turn-on rise time	tr			10		ns	2
Turn-off delay time	td(off)			30		ns	2
Turn-off fall time	tf	If=8A, dl/dt=100A/μs		65		ns	2
Body diode reverse recovery time	trr			42		ns	
Body diode reverse recovery charge	Qrr			30		nC	

NOTE :

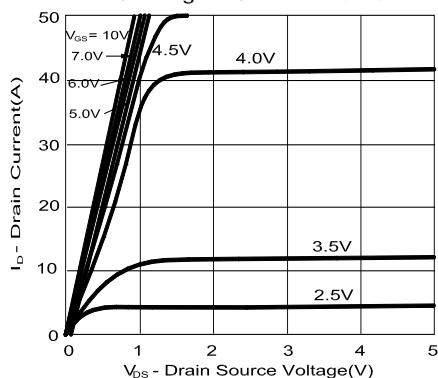
1. Pulse test : Pulse width ≤ 300 μsec, duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulse width limited by maximum junction temperature.

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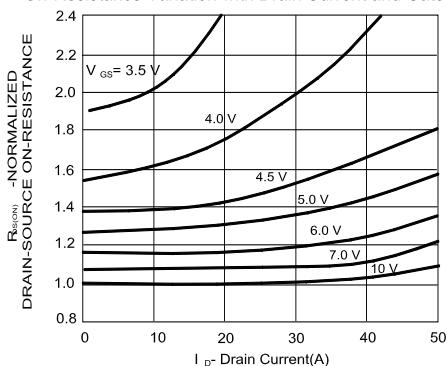
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■ Typical Electrical and Thermal Characteristics (N-ch)

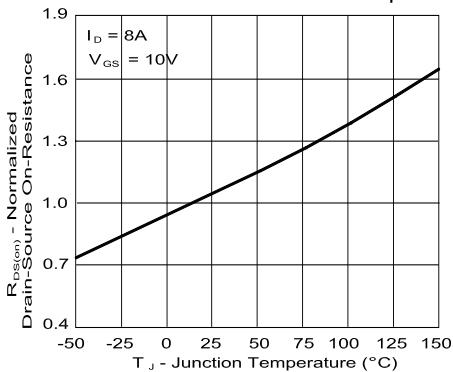
On-Region Characteristics



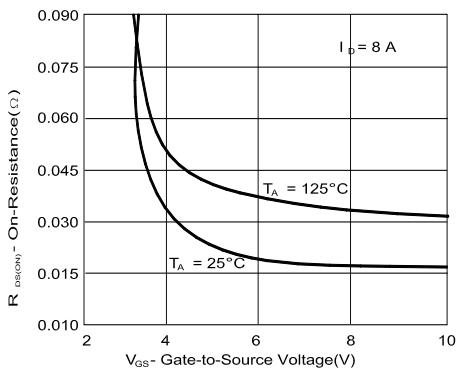
On-Resistance Variation with Drain Current and Gate Voltage



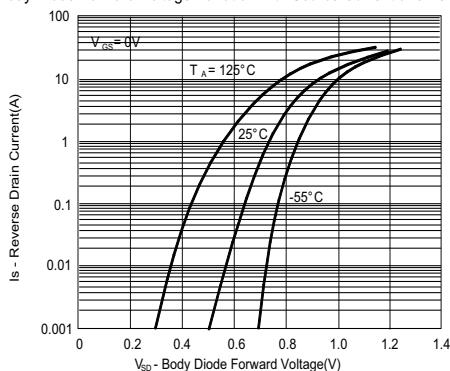
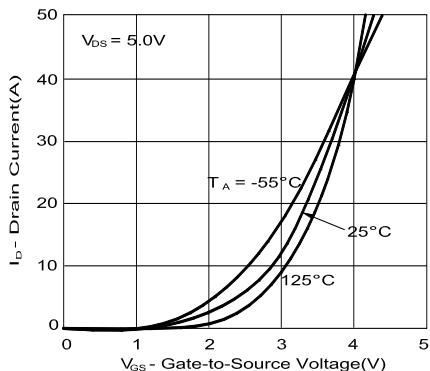
On-Resistance Variation with Temperature



On-Resistance Variation with Gate-to-Source Voltage

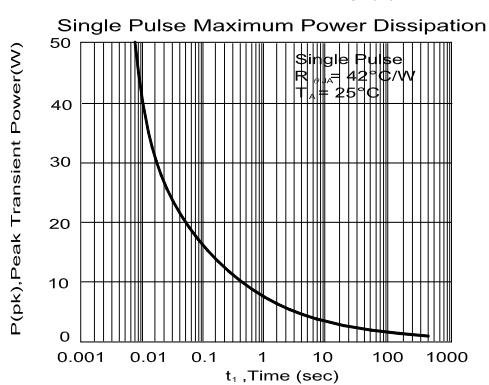
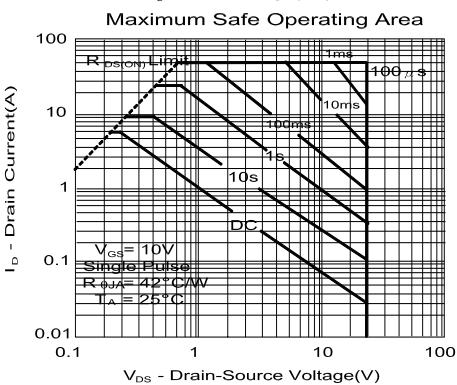
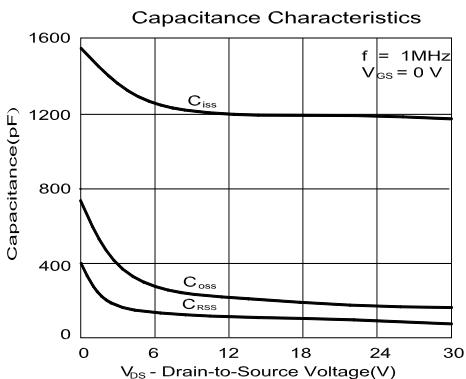
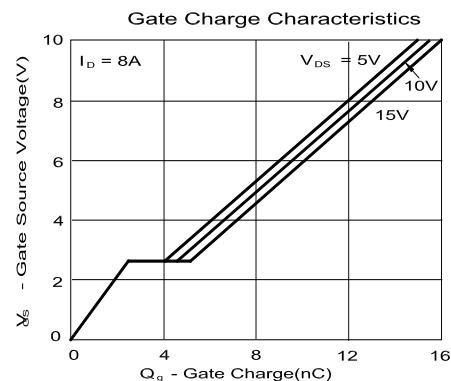


Body Diode Forward Voltage Variation with Source Current and Temperature



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■ Electrical Characteristics (P-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V	-30			V	
Zero gate voltage drain current	Idss	Vds=-24V, Vgs=0V			-1	μ A	
		Vds=-20V, Vgs=0V, Tj=55°C			-10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μA	-0.8	-1.5	-2.5	V	
On state drain current	Id(on)	Vgs=-10V, Vds=-5V	-50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=-10V, Id=-7A		28	35	m Ω	1
		Vgs=-4.5V, Id=-5A		46	60		
Forward transconductance	Gfs	Vds=-10V, Id=-7A		10		S	1
Diode forward voltage	Vsd	If=-3A, Vgs=0V			-1.2	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=-10V, f=1MHz		970		pF	
Output capacitance	Coss			270		pF	
Reverse transfer capacitance	Crss			180		pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=-10V, Vds=-15V Id=-7A		13		nC	2
Gate-source charge	Qgs			4		nC	2
Gate-drain charge	Qgd			6		nC	2
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V Id ≈ -1A, Rgen=3.3 Ω		22		ns	2
Turn-on rise time	tr			12		ns	2
Turn-off delay time	td(off)			32		ns	2
Turn-off fall time	tf			75		ns	2
Body diode reverse recovery time	trr	If=-7A, dl/dt=100A/μs		55		ns	
Body diode reverse recovery charge	Qrr			52		nC	

NOTE :

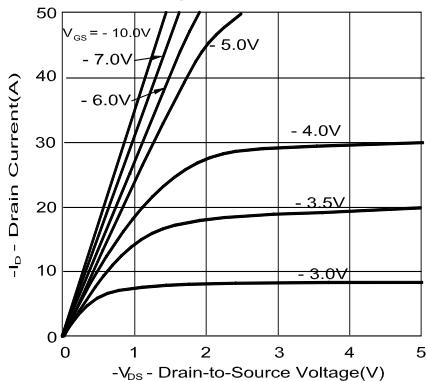
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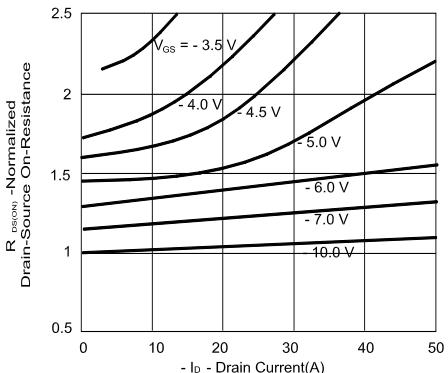
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■ Typical Electrical and Thermal Characteristics (P-ch)

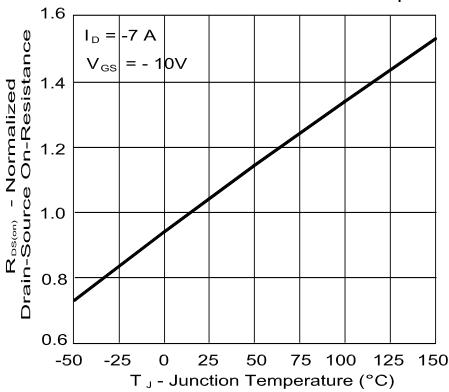
On-Region Characteristics



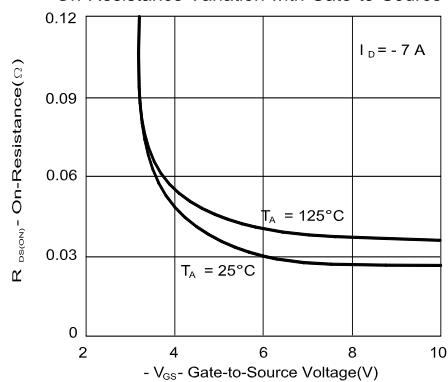
On-Resistance Variation with Drain Current and Gate Voltage



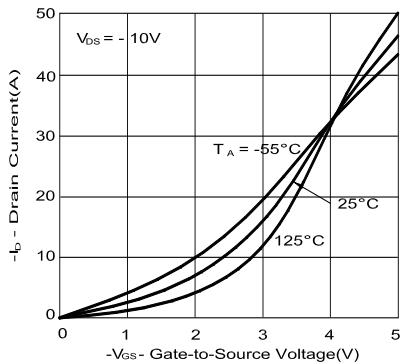
On-Resistance Variation with Temperature



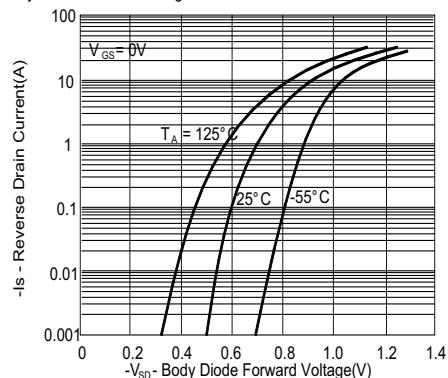
On-Resistance Variation with Gate-to-Source Voltage



Transfer Characteristics



Body Diode Forward Voltage Variation with Source Current and Temperature



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